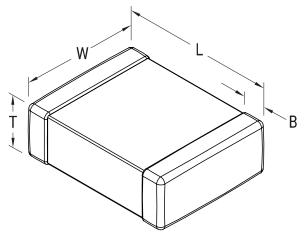




CBR-SMD RF COG, Ceramic, 2.3 pF, +/-0.05 pF, 25 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0201



Click here for the 3D model.

General Information	
Series	CBR-SMD RF COG
Style	SMD Chip
Description	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Features	Ultra High Q, Low ESR, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	0.3 mg
Notes	Solder Reflow Only.
Shelf Life	78 Weeks
MSL	1

2.3 pF +/-0.05 pF

Dimensions	
Chip Size	0201
L	0.6mm +/-0.03mm
W	0.3mm +/-0.03mm
т	0.3mm +/-0.03mm
В	0.15mm +/-0.05mm

+/-0.03mm	Voltage DC	25 VDC
+/-0.03mm	Dielectric Withstanding Voltage	62.5 VDC
+/-0.05mm	Temperature Range	-55/+125°C
	Temp. Coefficient	COG
	Dissipation Factor	0.224%
)mm, Plastic Tape	Aging Rate	0% Loss/Decade Hour
	Insulation Resistance	10 GOhms
	Quality Factor	446

Specifications Capacitance

Tolerance

Packaging Specifications		
Packaging	T&R, 180mm, Plastic Tape	
Packaging Quantity	15000	

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and
we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the
requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us
with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.